

ON Semiconductor®

FDN358P

Single P-Channel, Logic Level, PowerTrench[®] MOSFET

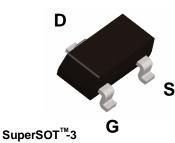
General Description

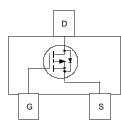
This P-Channel Logic Level MOSFET is produced using ON Semiconductor advanced Power Trench process that has been especially tailored to minimize the on-state resistance and yet maintain low gate charge for superior switching performance.

These devices are well suited for portable electronics applications: load switching and power management, battery charging circuits, and DC/DC conversion.

Features

- -1.5 A, -30 V. $R_{DS(ON)} = 125 \text{ m}\Omega @ V_{GS} = -10 \text{ V}$ $R_{DS(ON)} = 200 \text{ m}\Omega @ V_{GS} = -4.5 \text{ V}$
- Low gate charge (4 nC typical)
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$.
- High power version of industry Standard SOT-23 package. Identical pin-out to SOT-23 with 30% higher power handling capability.





Absolute Maximum Ratings T_A=25°C unless otherwise noted

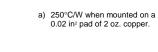
Symbol	Parameter		Ratings	Units	
V _{DSS}	Drain-Source Voltage		-30		
V _{GSS}	Gate-Source Voltage		±20	V	
ID	Drain Current – Continuous	(Note 1a)	-1.5	A	
	– Pulsed		-5		
P _D	Power Dissipation for Single Operation	(Note 1a)	0.5	W	
		(Note 1b)	0.46	VV	
T _J , T _{STG}	Operating and Storage Junction Temperatu	ire Range	-55 to +150	°C	
Therma	I Characteristics				
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	250	°C/W	
R _{eJC}	Thermal Resistance, Junction-to-Case	(Note 1)	75	°C/W	

Package Marking and Ordering InformationDevice MarkingDeviceReel SizeTape widthQuantity358FDN358P7"8mm3000 units

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
Off Char	acteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = -250 \mu A$	-30			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		-22		mV/°(
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -24V$, $V_{GS} = 0V$ $V_{DS} = -24V$, $V_{GS} = 0V$, $T_J=55^{\circ}C$			-1 -10	μΑ
I _{GSSF}	Gate-Body Leakage, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
	Gate–Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
	acteristics (Note 2)					
	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = -250 μA	-1	-1.9	-3	V
$\Delta V_{GS(th)}$ ΔT_J	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C	1	4	0	mV/°
R _{DS(on)}	Static Drain–Source On–Resistance	$V_{GS} = -10 \text{ V}, \qquad I_D = -1.5 \text{ A}$		105	125	mΩ
		V _{GS} = −10 V, I _D = −1.5 A,T _J =125°C		148	210	
				161	200	
D(on)	On-State Drain Current		-5			Α
g fs	Forward Transconductance	$V_{DS} = -5 V$, $I_D = -1.5 A$		3.5		S
Dynamio	Characteristics			•	•	
Ciss	Input Capacitance	$V_{DS} = -15 \text{ V}, \qquad V_{GS} = 0 \text{ V},$ f = 1.0 MHz		182		pF
Coss	Output Capacitance			56		pF
C _{rss}	Reverse Transfer Capacitance			26		pF
Switchir	g Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time			5	10	ns
t _r	Turn–On Rise Time			13	23	ns
t _{d(off)}	Turn–Off Delay Time			12	21	ns
t _f	Turn–Off Fall Time			2	4	ns
Qg	Total Gate Charge	$ \begin{array}{ll} V_{DS} = -15 V, & I_{D} = -1.5 \; A, \\ V_{GS} = -10 \; V \end{array} $		4	5.6	nC
Q _{gs}	Gate-Source Charge			0.8		nC
Q _{gd}	Gate-Drain Charge			0.8		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings				
Is	Maximum Continuous Drain-Source				-0.42	Α
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 \ V, I_S = -0.42 \ A \ (Note 2)$		-0.76	-1.2	V



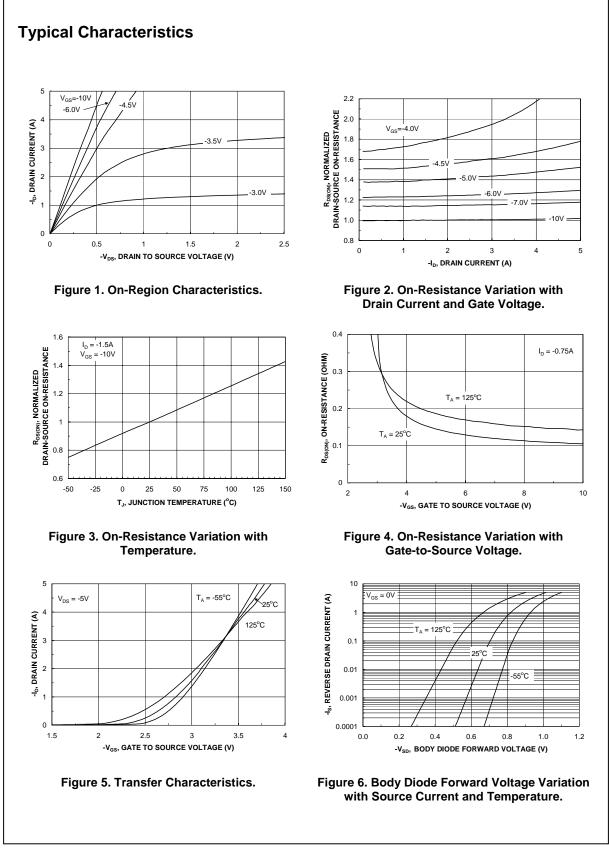
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b) 270°C/W when mounted on a minimum pad.

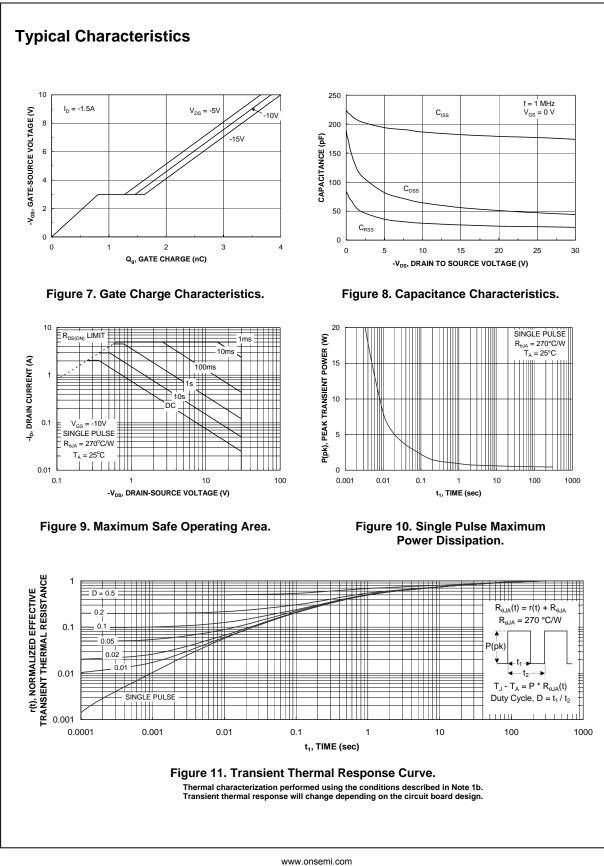
Ś Scale 1:1 on letter size paper

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2. Pulse Test: Pulse Width $\leq 300~\mu\text{s},~\text{Duty}~\text{Cycle} \leq 2.0\%$



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